

Lecture 1: X-ray Basic Physics, System Parameters and Qualitative Analysis - (Day 1)

- I. System Description
 - A. Components
 - 1. Spectrometer
 - 2. Electronics
 - 3. Analyzer hardware
 - B. Spectrometer resolution
 - C. Spectrometer efficiency
- II. Data Collection
 - A. Energy calibration
 - B. Count rate considerations
 - 1. Statistics
 - 2. (3 Sigma Rule)
- III. X-ray Physics
 - A. Generation of x-rays
 - 1. Characteristics of x-rays
 - 2. Continuum
 - 3. Artifact peaks
 - B. Moseley's Law
 - C. Beer's Law
- IV. Microscope/Detector Parameters
 - A. Sample/Detector geometry
 - B. Probe current
 - C. X-ray range (volume)
- V. Qualitative Analysis
 - A. Parameters
 - 1. Accelerating voltage
 - 2. Sample/Detector geometry
 - 3. Probe current/Count rate
 - B. Identification
 - C. Dealing with overlaps

Laboratory 1: X-ray Basic operation and Qualitative Analysis

- I. Overview of System
 - A. Detector
 - 1. Components
 - 2. Filling Dewar
 - 3. LN₂ monitor
 - 4. Bias control
 - 5. Variable X
 - 6. Variable Y
 - B. Analyzer
 - 1. Components
 - 2. Software
 - a. Version
 - b. Booting system
 - 3. Display
 - 4. Mouse/Keyboard operation
 - C. Calibration
 - D. General X-ray data collection
- II. Qualitative analysis and general operation
 - A. Display spectra
 - B. Spectra control

- C. *Identification*
 - 1. *Manual*
 - 2. *Computer-assisted*
 - 3. *Automatic*
 - 4. *Escape/sum*
- D. *Checking detector efficiency*
- E. *Handling overlaps*
 - 1. *Recognizing overlaps*
 - 2. *Comparing spectra*
 - 3. *Using background subtraction*
 - 4. *Relative ratios*

Lecture 2: Comparative Analysis - (Day 2)

- I. *Comparative Analysis*
 - A. *Relative ratio/Match/Fingerprint Analysis*
 - B. *K-ratio*
 - C. *Concentration curve*
 - D. *Graphic techniques*
 - 1. *Analog dot mapping and line profiles*
 - 2. *Digital mapping and line profiles*
 - 3. *Position tagged spectrometry (PTS / HyperMap)*
- II. *General X-ray Techniques*
 - A. *Ideal sample*
 - B. *Sample charging*
 - C. *Rough surface/powder*
 - D. *Multi-phase*
 - E. *Thin films*
 - F. *Foils*
 - G. *Particles on substrate*

Laboratory 2: Mapping, Line scan and Comparative Techniques

- I. *Collection of SpotLight / Multi-point, X-ray maps, line profiles, PTS / HyperMap. Review of ID and overlaps*
- II. *Comparative Analysis*
 - A. *Relative ratio/Match Analysis*
 - B. *K-ratio*
 - C. *Subtracting substrates*

Lecture 3: Quantitative Analysis - (Day 3)

- I. *Theory*
- II. *Background subtraction*
- III. *K-ratio/Deconvolution*
- IV. *Matrix correction*
- V. *Standards versus standardless*
- VI. *Microscope parameters*
 - A. *Accelerating voltage*
 - B. *Sample/Detector geometry*
 - C. *Count rate*
 - D. *Probe current*
- V11. *Description of Bruker Quantitative Programs*

Laboratory 3: Quantitative Analysis

- I. *Setting up quant*
 - A. *Take-off angle*
 - B. *Efficiency*
- II. *Standardless Analysis*
- III. *Partial standards analysis*
- III. *Full standards analysis*
- IV. *Rough surface/powder*
- V. *Thin section (Cliff-Lorimar)*
- VI. *Hall*
- VII. *Output*

Lecture 4: Digital Image; Analysis and Processing - (Day 3)

- I. *Terminology*
- II. *What is digital imaging?*
- III. *Sources*
- IV. *Calibration*
- V. *Image Processing*
 - A. *Transforms*
 - B. *Filters*
 1. *Arithmetic*
 2. *Logic*
 - H. *Binary*
 - C. *Math operations*
 - D. *Artificial intelligence programs*
 - E. *Cross fibers*
- VI. *Image Analysis*
 - A. *Area fraction*
 - B. *Point to point*
 - C. *Feature*
 - D. *Critical dimension*
 - E. *Coatings thickness*
 - F. *Stereo depth measurements*

Laboratory 4: Digital Imaging – (Day 4)

- I. *Optimize image collection*
- II. *Basic display operations*
- III. *Advanced operations*

At the end of each day: (Optional: open lab and review)